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1. Name of conveying party JM - 7  Taku INOUE FINANCE S  Additional name(s) of conveying party( attached?Yes _X_No	ECTION ies)	2. Name and address of SONY CORPORA 7-35 Kitashinagawa-Ku, Tok	TION
3. Nature of conveyance:  X Assignment Security Agreement Merger Change of Name Other Execution Date(s): December 22, 2005		Additional name(s)	& address(es) attached? YesX_No
<ol> <li>Application number(s) or patent number</li> <li>If this document is being filed together</li> <li>A. Patent Application No. 11/268,239</li> <li>Additional numbers attached? Yes</li> </ol>	with a new application, the filed November 7, 2005.	execution date of the applicati	ion is:
5. Name and address of party to whom condocument should be mailed:  Name: WILLIAM S. FROM Internal Address: FROMMER LAWF Street Address: 745 FIFTH AVENU City: NEW YORK State	MMER RENCE & HAUG LLP JE	7. Total fee (37 CFR 3  X Enclosed  Authorized to b  8. Deposit account nu	e charged to deposit account 50-0320
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9. Statement and signature.  To the best of my knowledge and belief  Thomas F. Presson, Reg. No. 41,442	the foregoing information	is true and correct and any att	January 6, 2006
Name of Person Signing		Signature	Date  Total number of pages including cover sheet, attachments, and document: 2

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00334789

FLH Docket Number: 450100-05723

## **ASSIGNMENT**

WHEREAS, I, as below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

## BROADCAST-DATA DISPLAY CONTROL DEVICE AND METHOD, AND BROADCAST-DATA RECEIVING DEVICE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese Corporation, with offices at 7-35 Kitashinagawa 6-chome, Shinagawa-Ku, Tokyo, 141-0001, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/268,239, Filing Date: November 7, 2005.

This assignment executed on the dates indicated below.

Taku INOUE			
Name of sole or 1st inventor	Execution date of U.S. Patent Application		
Kanagawa, Japan			
Residence of sole or 1st inventor			
Jaku Inoue	December 22, 2005		
Signature of sole or 1st inventor	△Date of this assignment		

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PATENT REEL: 017438 FRAME: 0356